



kimvo

## Homopolymer General Purpose Grade Resin

**F680** is especially suited for processing from powder blends due to its ability to rapidly absorb plasticizers regardless of molecular weight. In addition, this product offers:

*Excellent Electrical Properties	*Low Contamination
*Low Gel Content	*Excellent Heat Stability
*High Finished Product Physical Properties	*Lot To Lot Uniformity

## **Suggested Applications:**

Flexible Calendering, Extrusion, Medical, Blown Film and Wire and Cable.

<u>Properties</u>	Test Method	<u>Typical Value</u>
Relative Viscosity	estimated	2.37
Inherent Viscosity	ASTM D-5225	1.02
K-Value	estimated	70
Volatiles (%)	ASTM D-6980	0.20
Bulk Density (lbs/ft3)	ASTM D-1895	32
(g/cc)		0.51
Sieve Analysis	Malvern	
% thru 40 Mesh		99.9
% thru 200 Mesh		4
Residual VCM (ppm)	GC Head Space Method	<1.0
Contamination Count	OCS per 100g	20
Gel Count	GP Gel Method	10

Effective as of November 2015

BC Definition Definiti

Any inquiries regarding this data sheet should be addressed to: 9 Peach Tree Hill Road • Livingston, NJ 07039 • Phone: (888) FPCUSA3 • Fax: (973) 422-7724

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